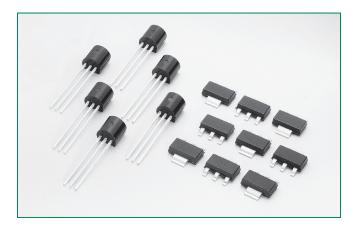


HF RoHS Sx02xS Series



Main Features

| Symbol | Value | Unit |
|------------------------------------|------------|------|
| I _{T(RMS)} | 1.5 | А |
| V _{DRM} /V _{RRM} | 400 to 600 | V |
| I _{GT} | 200 | μΑ |

Applications

The Sx02xS EV series is specifically designed for Gas Ignition applications that require high pulse surge current capability.

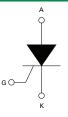
Description

New 1.5 Amp sensitive gate SCR series offers high static dv/dt with low turn off time (tq) through small die planar construction design. All SCR's junctions are glasspassivated to ensure long term reliability and parametric stability.

Features

- RoHS compliant and Halogen-Free
- Thru hole and surface mount packages
- Surge capability > 15Amps
- Blocking voltage (V_{DRM}/V_{RRM}) capability — up to 600V
- High dv/dt noise immunity
- Improved turn-off time (tq) < 35 µsec.
- Sensitive gate for direct microprocessor interface

Schematic Symbol



Absolute Maximum Ratings

| Symbol | Parameter | | Value | Unit | |
|---------------------|---|------------------------|---------------------------------|------------|------------------|
| | RMS on-state current | TO-92 | $T_{c} = 65^{\circ}C$ | 1.5 | А |
| I _{T(RMS)} | (full sine wave) | SOT-223 | T _L = 95°C | 1.5 | A |
| | Average on-state current | TO-92 | $T_{\rm C} = 65^{\circ}{\rm C}$ | 0.95 | А |
| T(AV) | Average on-state current | SOT-223 | $T_{\rm C} = 95^{\circ}{\rm C}$ | 0.95 | |
| | Non repetitive surge peak on-state current | TO-92 | F = 50 Hz | 12.5 | А |
| I _{TSM} | (Single cycle, T _J initial = 25°C) | SOT-223 | F = 60 Hz | 15.0 | A |
| l²t | I²t Value for fusing | $t_p = 10 \text{ ms}$ | F = 50 Hz | 0.78 | A ² s |
| | i t value for fushing | $t_p = 8.3 \text{ ms}$ | F = 60 Hz | 0.93 | A 5 |
| di/dt | Critical rate of rise of on-state current IG = 10mA | TO-92 SOT-223 | T _J = 125°C | 50 | A/µs |
| I _{GM} | Peak gate current $t_p = 10 \mu s$ $T_J = 125^{\circ} (t_p - 10 \mu s)$ | | | 1.0 | А |
| P _{G(AV)} | Average gate power dissipation $T_J = 125^{\circ}C$ | | | 0.1 | W |
| T _{stg} | Storage junction temperature range | | | -40 to 150 | °C |
| T _J | Operating junction temperature range | -40 to 125 | °C | | |

Teccor® brand Thyristors EV Series 1.5 Amp Sensitive SCRs



Electrical Characteristics (T_J = 25°C, unless otherwise specified)

| Constant | Description | Total Complisions | Sx0 | 2xS | 11.54 |
|------------------|---|---|-----|-----|-------|
| Symbol | Description | Test Conditions | Min | Max | Unit |
| I _{GT} | DC Gate Trigger Current | V _D = 12V | 15 | 200 | μА |
| V _{GT} | DC Gate Trigger Voltage | R _L = 60 Ω | _ | 0.8 | V |
| V _{GRM} | Peak Reverse Gate Voltage | $I_{RG} = 10 \mu A$ | 5 | _ | V |
| I _H | Holding Current | $R_{GK} = 1 k\Omega$ | _ | 5 | mA |
| (dv/dt)s | Critical Rate-of-Rise of Off-State Voltage | $T_J = 125^{\circ}\text{C}$ $V_D = V_{DRM} / V_{RRM}$ Exponential Waveform $R_{GK} = 1 \text{ k}\Omega$ | 25 | _ | V/µs |
| t _q | Turn-Off Time | $T_J = 125^{\circ}C @ 600 V$ $R_{GK} = 1 k\Omega$ | _ | 35 | μs |
| t _{gt} | Turn-On Time | $I_{\rm G} = 10$ mA PW = 15 μ sec $I_{\rm T} = 3.0$ A (pk) | _ | 3 | μs |

Static Characteristics (T_J = 25°C, unless otherwise specified)

| Symbol | Description | Test Conditions Valu | | lue | Unit | |
|------------------|------------------------------------|--|-----|------|-------|--|
| Syllibol | Description | lest Conditions | Min | Max | Offic | |
| V _{TM} | Peak On-State Voltage | $I_{TM} = 3.0A \text{ (pk)}$ | _ | 1.70 | V | |
| | Off-State Current, Peak Repetitive | $T_J = 25^{\circ}C @V_D = V_{DRM}$ $R_{GK} = 1 k\Omega$ | _ | 5 | μΑ | |
| I _{DRM} | On-State Current, Feak nepetitive | $T_J = 125^{\circ}C @V_D = V_{DRM}$ $R_{GK} = 1 k\Omega$ | _ | 500 | μΑ | |

Thermal Resistances

| Symbol | Description | Test Conditions | | Value | Unit |
|----------------------|-----------------------|---|---------|-------|-------|
| D | lunation to coop (AC) | I 15A 1 | TO-92 | 50 | 0CAA/ |
| $R_{th(j-c)}$ | Junction to case (AC) | Inction to case (AC) $I_T = 1.5A_{(RMS)}^{1}$ | | 25 | °C/W |
| D | lunation to ambient | 1 150 1 | TO-92 | 160 | 0CAA/ |
| $R_{\text{th(j-a)}}$ | Junction to ambient | $I_{T} = 1.5A_{(RMS)}^{1}$ | SOT-223 | 60 | °C/W |

¹ 60Hz AC resistive load condition, 100% conduction.



Figure 1: Normalized DC Gate Trigger Current vs. Junction Temperature

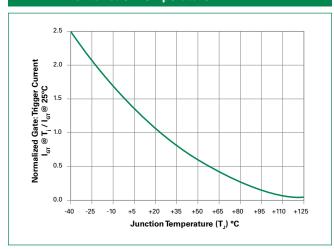


Figure 2: Normalized DC Holding Current vs. Junction Temperature

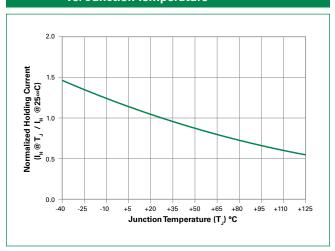


Figure 3: Normalized DC Gate Trigger Voltage vs. Junction Temperature

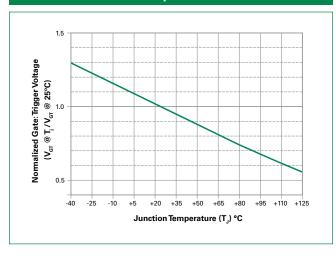


Figure 4: Power Dissipation (Typical) vs. RMS On-State Current

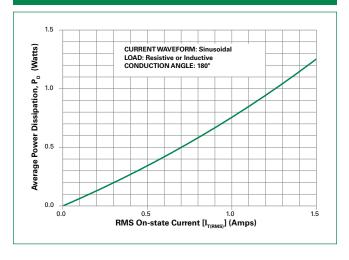


Figure 5: Maximum Allowable Case Temperature vs. On-State Current

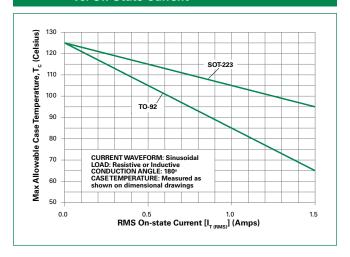
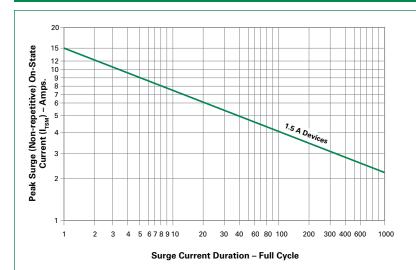


Figure 6: Surge Peak On-State Current vs. Number of Cycles



Supply Frequency: 60Hz Sinusoidal Load: Resistive

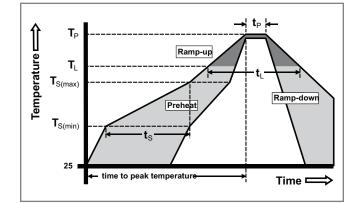
RMS On-State Current $[I_{\text{T(RMS)}}]$: Max Rated Value at Specific Case Temperature

Gate control may be lost during and immediately following surge current interval.

Overload may not be repeated until junction temperature has returned to steady-state rated value.

Soldering Parameters

| Reflow Co | ndition | Pb – Free assembly | |
|---|---|-------------------------|--|
| | -Temperature Min (T _{s(min)}) | 150°C | |
| Pre Heat | -Temperature Max (T _{s(max)}) | 200°C | |
| | -Time (min to max) (t _s) | 60 – 180 secs | |
| Average ra | amp up rate (LiquidusTemp) k | 5°C/second max | |
| T _{S(max)} to T _L | - Ramp-up Rate | 5°C/second max | |
| Reflow | -Temperature (T _L) (Liquidus) | 217°C | |
| nellow | -Time (min to max) (t _s) | 60 – 150 seconds | |
| PeakTemp | erature (T _P) | 260 ^{+0/-5} °C | |
| Time within 5°C of actual peak Temperature (t _p) | | 20 - 40 seconds | |
| Ramp-dov | vn Rate | 5°C/second max | |
| Time 25°C | to peakTemperature (T _P) | 8 minutes Max. | |
| Do not exc | ceed | 280°C | |
| | | | |





Physical Specifications

| Terminal Finish | 100% Matte Tin-plated. | |
|-----------------|--|--|
| Body Material | UL recognized epoxy meeting flammability classification 94V-0. | |
| Lead Material | Copper Alloy | |

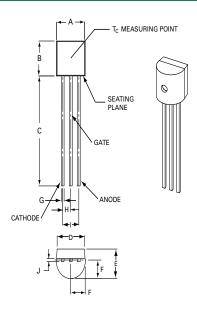
Design Considerations

Careful selection of the correct device for the application's operating parameters and environment will go a long way toward extending the operating life of the Thyristor. Good design practice should limit the maximum continuous current through the main terminals to 75% of the device rating. Other ways to ensure long life for a power discrete semiconductor are proper heat sinking and selection of voltage ratings for worst case conditions. Overheating, overvoltage (including dv/dt), and surge currents are the main killers of semiconductors. Correct mounting, soldering, and forming of the leads also help protect against component damage.

Environmental Specifications

| Test | Specifications and Conditions |
|---------------------------|---|
| AC Blocking | MIL-STD-750, M-1040, Cond A Applied Peak AC voltage @ 125°C for 1008 hours |
| Temperature Cycling | MIL-STD-750, M-1051, 100 cycles; -40°C to +150°C; 15-min dwell-time |
| Temperature/ Humidity | EIA / JEDEC, JESD22-A101 1008 hours; 320V - DC: 85°C; 85% rel humidity |
| High Temp Storage | MIL-STD-750, M-1031, 1008 hours; 150°C |
| Low-Temp Storage | 1008 hours; -40°C |
| Thermal Shock | MIL-STD-750, M-1056 10 cycles; 0°C to 100°C; 5-min dwell- time at each temperature; 10 sec (max) transfer time between temperature |
| Autoclave | EIA / JEDEC, JESD22-A102 168 hours (121°C at 2 ATMs) and 100% R/H |
| Resistance to Solder Heat | MIL-STD-750 Method 2031 |
| Solderability | ANSI/J-STD-002, category 3, Test A |
| Lead Bend | MIL-STD-750, M-2036 Cond E |

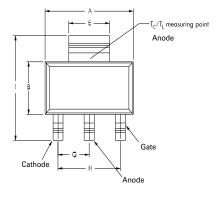
Dimensions — TO-92 (E Package)

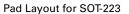


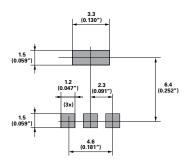
| Dimensions | Inc | hes | Millin | neters |
|------------|-------|-------|--------|--------|
| Dimensions | Min | Max | Min | Max |
| А | 0.175 | 0.205 | 4.450 | 5.200 |
| В | 0.170 | 0.210 | 4.320 | 5.330 |
| С | 0.500 | | 12.70 | |
| D | 0.135 | | 3.430 | |
| Е | 0.125 | 0.165 | 3.180 | 4.190 |
| F | 0.080 | 0.105 | 2.040 | 2.660 |
| G | 0.016 | 0.021 | 0.407 | 0.533 |
| Н | 0.045 | 0.055 | 1.150 | 1.390 |
| I | 0.095 | 0.105 | 2.420 | 2.660 |
| J | 0.015 | 0.020 | 0.380 | 0.500 |



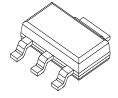
Dimensions - SOT-223

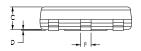


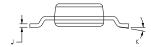




Dimensions in Millimeters (Inches)







| Dimonoiono | | Inches | | Millimeters | | |
|------------|---------|--------|-------|-------------|------|------|
| Dimensions | Min | Тур | Max | Min | Тур | Max |
| А | 0.248 | 0.256 | 0.264 | 6.30 | 6.50 | 6.70 |
| В | 0.130 | 0.138 | 0.146 | 3.30 | 3.50 | 3.70 |
| С | _ | _ | 0.071 | _ | _ | 1.80 |
| D | 0.001 | _ | 0.004 | 0.02 | _ | 0.10 |
| Е | 0.114 | 0.118 | 0.124 | 2.90 | 3.00 | 3.15 |
| F | 0.024 | 0.027 | 0.034 | 0.60 | 0.70 | 0.85 |
| G | _ | 0.090 | _ | _ | 2.30 | _ |
| Н | _ | 0.181 | _ | _ | 4.60 | _ |
| I | 0.264 | 0.276 | 0.287 | 6.70 | 7.00 | 7.30 |
| J | 0.009 | 0.010 | 0.014 | 0.24 | 0.26 | 0.35 |
| K | 10° MAX | | | | | |

Product Selector

| Part Number | Voltage Voltage | | Cata Canaitivity | Dookomo |
|-------------|-----------------|------|------------------|---------|
| ran Number | 400V | 600V | Gate Sensitivity | Package |
| S402ES | X | _ | 200μΑ | TO-92 |
| S602ES | _ | X | 200μΑ | TO-92 |
| S402TS | X | _ | 200μΑ | SOT-223 |
| S602TS | _ | X | 200μΑ | SOT-223 |

Packing Options

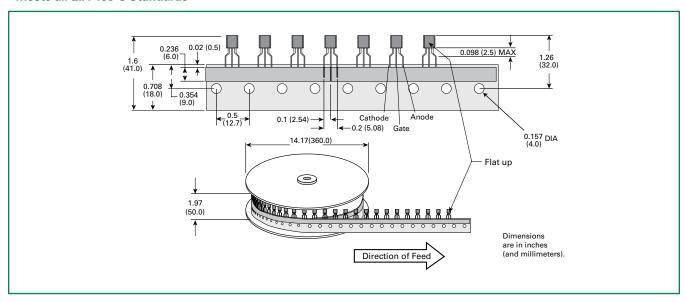
| Part Number | Marking | Weight | Packing Mode | Base Quantity |
|-------------|---------|---------|--------------|---------------|
| Sx02ES | Sx02ES | 0.170 g | Bulk | 2500 |
| Sx02ESAP | Sx02ES | 0.170 g | Ammo Pack | 2000 |
| Sx02ESRP | Sx02ES | 0.170 g | Tape & Reel | 2000 |
| Sx02TSRP | Sx02TS | 0.120 g | Tape & Reel | 1000 |

Note: x = voltage



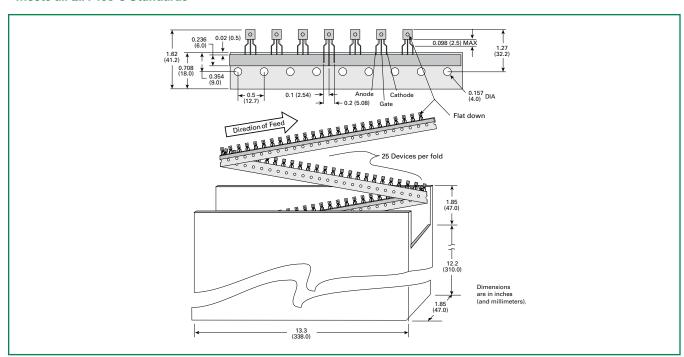
TO-92 (3-lead) Reel Pack (RP) Radial Leaded Specifications

Meets all EIA-468-C Standards



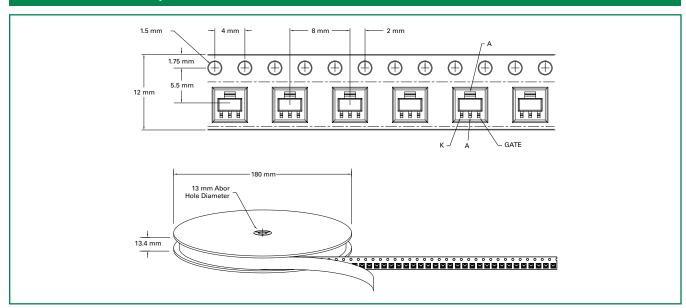
TO-92 (3-lead) Ammo Pack (AP) Radial Leaded Specifications

Meets all EIA-468-C Standards

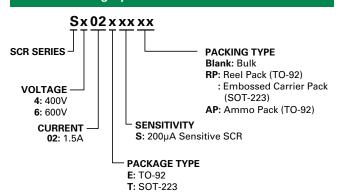




SOT-223 Reel Pack (RP) Specifications



Part Numbering System



Part Marking System

